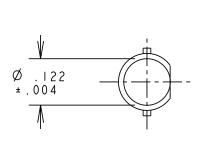
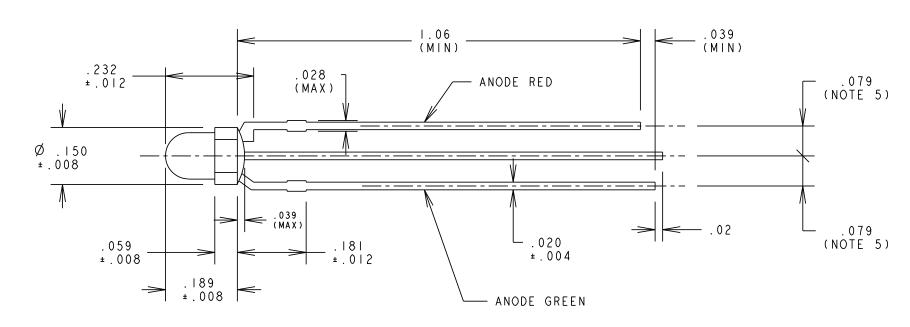
REV	ECN NO	REVISIONS	DRN	CKD	APP	DATE
Α		NEW RELEASE	TWC			





OPERATING CHARACTERISTICS AT 25°C AMBIENT

LED CHARACTERISTICS	COLOR	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
LUMINOUS INTENSITY	RED GREEN	4 6	8 12		mc d	I _F = 20 mA
FORWARD VOLTAGE	RED GREEN		2.0 2.1	2.5	٧	I _F = 20 mA
REVERSE CURRENT	RED GREEN			20	μΑ	V _R = 4 V
PEAK WAVELENGTH (λ _ρ)	RED GREEN		630 560		nm	
VIEWING ANGLE (2 © 1/2)	RED GREEN		80		deg.	
CAPACITANCE	RED GREEN		35 40		pF	V _F = 0; f = 1 MHz

ABSOLUTE MAXIMUM RATINGS AT 25° C AMBIENT	RED	GREEN	UNITS
POWER DISSIPATION	7.5	7.5	mW
DERATE LINEARLY FROM 25° C	0.85	0.85	mW/°C
CONTINUOUS FORWARD CURRENT	30	30	m A
PEAK FORWARD CURRENT	100	100	mA
REVERSE VOLTAGE	4	4	٧
LEAD SOLDERING TEMPERATURE, 5 SEC., 1/16" FROM BODY	20	260	
OPERATING TEMPERATURE	-30 TO +85 -30 TO +100		°C
STORAGE TEMPERATURE			°C



- I. EPOXY COLOR: WHITE DIFFUSED.
- DIE: GaAsP/GaP RED & GaP GREEN.
 LEAD FINISH: SILVER (Ag) 2.5 MICRONS, COPPER (Cu) 1.5 MICRONS, BASE LEAD FRAME IRON.
- 4. SOLDER ADHERANCE: BOTH LEADS PER MIL. STD. 202E, METHOD 208C.
- LEAD SPACING MEASURED NEAR EPOXY PACKAGE.
 THIS ASSEMBLY CONTAINS ELECTROSTATIC DISCHARGE SENSITIVE DEVICES (ESDS). MAINTAIN ALL PRECAUTIONARY MEASURES DURING ASSEMBLY, HANDLING AND STORAGE IN ACCORDANCE WITH IPC-A-610.

RoHS Compliant 521-9664F Thru hole Bi-color LED

Part Numbers with the "F" suffix ending are RoHS Compliant. Packaging is marked with "RoHS Compliant" label or equivalent markings.

Parts can be wave soldered, dip soldered or hand soldered using typical lead-free soldering process with max 260°C temp. for 5 sec.

